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02/15/2002

10027

PATENT NUMBER and
ISSUE DATE

U.S. UTILITY Patent Application

APPL NUM 10078016	FILING DATE 02/15/2002	CLASS 427	SUBCLASS 685	GAU 1762	EXAMINER THANH NGUYEN
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**APPLICANTS: Herner Scott;

**CONTINUING DATA VERIFIED: None
TN

** FOREIGN APPLICATIONS VERIFIED: None
TN

PG-PUB DO NOT PUBLISH ☐

RESCIND ☐

Foreign priority claimed

☐ yes ☒ no

35 USC 119 conditions met

☐ yes ☒ no

Verified and Acknowledged Examiner's initials

ATTORNEY DOCKET NO

A5031/T43300

TITLE : High throughput process for the formation of a refractory metal nucleation layer

U.S. DEPT. OF COMM./PAT. & TM.-PTO-4352 (Rev. 12-94)

NOTICE OF ALLOWANCE MAILED		CLAIMS ALLOWED	
		Total Claims	Print Claim for O.G.
Assistant Examiner			
ISSUE FEE		DRAWING	
Amount Due	Date Paid	Sheets Drwg.	Figs. Drwg.
		Print Fig.	
<input type="checkbox"/> TERMINAL DISCLAIMER		Primary Examiner PREPARED FOR ISSUE Application Examiner	
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